Data Sheet



V 1.1 / Feb. 2015

MSM261S4030H0

I²S digital output MEMS microphone with Multi-modes













GENERAL DESCRIPTION

MSM26S4030H0 is an omnidirectional, bottom-ported, I²S digital output MEMS microphone. It has high performance and reliability.

MSM26S4030H0 is available in a 4 mm \times 3 mm \times 1.0 mm metal cap LGA package. It is SMT compatible with no sensitivity degradation.

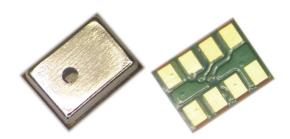
APPLICATIONS

- ♦ Mobile Phone
- ♦ Laptop
- ♦ Tablet computer
- ♦ Bluetooth headset
- ♦ Earphone
- ♦ Wearable intelligent equipment

FEATURES

- ♦ Cost effective
- ♦ Low Power mode
- ♦ Digital I²S output
- Compatible with Sn/Pb and Pb-free solder processes
- ♦ RoHS/Halogen free compliant
- ♦ Sensitivity Matching within +/-1dB

PRODUCT VIEW















ABSOLUTE MAXIMUM RATINGS

Parameter	Maximum value	Unit
Supply Voltage	-0.3 to 4.0	V
Sound Pressure Level	140	dB SPL
Mechanical Shock	10,000	g
Temperature Range	-40 to 100	°C
Electrostatic discharge protection	2 (HBM)	kV

SPECIFICATIONS

All data taken at 25°C, Relative Humidity 45±5% L/R pin grounded unless otherwise specified Vdd=1.8V, clock frequency=3.072MHz

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	Limits			unit	condition	
	Min.	Nom.	Max.			
Directivity	C	Omni direction	al			
Sensitivity	-27	-26	-25	dB	dBFS @1kHz 1Pa	
Operation voltage	1.6		3.6	V		
Freq. range	Refer to	the frequency	response	Hz		
Sensitivity loss across supply voltage	No change	across the vo	Itage range	dB		
Signal to noise ratio	-	57	-	dB	20 kHz bandwidth, A-weighted	
TUD	-	-	1%		100dB SPL @1kHz	
THD	-	-	10%		120dB SPL @1kHz	
PSR		-72		dBFS(A)		
Current concumption	ı	750	1000	μΑ	Normal mode	
Current consumption	ı	400	=	μΑ	Low power mode	
Clack fraguancy	1.0	3	4.0	MHz	Normal mode	
Clock frequency	150	-	600	KHz	Low power mode	
Operating temperature	-40	-	100	°C		
Storage temperature	-40	-	100	°C		



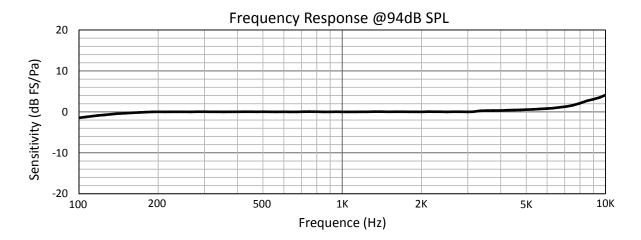








TYPICAL FREQUENCY RESPONSE



LOGIC TABLE

	Parameter	Symbol	Min	Max	Unit
Digital	Digital Low Voltage Input(L/R, WS, SCK)		0	0.25 × VDD	V
Input	High Voltage Input(L/R, WS, SCK)	VIH	0.7 × VDD	VDD	V
	Voltage Output Low	VOL		0.1 × VDD	V
	Voltage Output Low	VOL		0.3 × VDD	V
SD	Voltage Output High	VOH	0.7 × VDD		V
Digital	Voltage Output High	VOH	0.9 × VDD		V
Digital	Voltage Output Low	VOL		0.1 × VDD	V
Output	Voltage Output Low	VOL		0.3 × VDD	V
·	Voltage Output High	VOH	0.7 × VDD		V
	Voltage Output High	VOH	0.9 × VDD		V





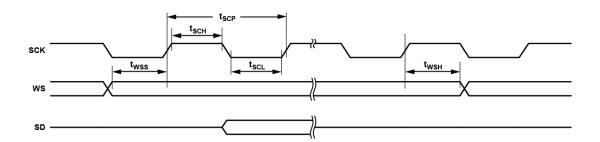






TIMING DIAGRAM

Parameter	Description	Min.	Norm.	Max.	Unit
tSCH	SCK High		50		ns
tSCL	SCK Low		50	1	ns
tSCP	SCK Period		325		ns
fSCK	SCK Frequency	_	3.072		MHz
tWSS	WS Setup		0	1	ns
tWSH	WS Hold	_	20		ns
fWS	WS Frequency	_	7.8		kHz

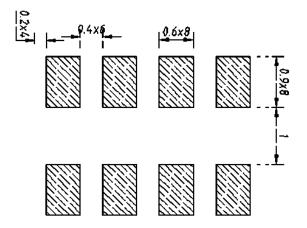






SMT Parameters:

1. Recommend PCB land pattern layout and stencil pattern: (unit: mm)









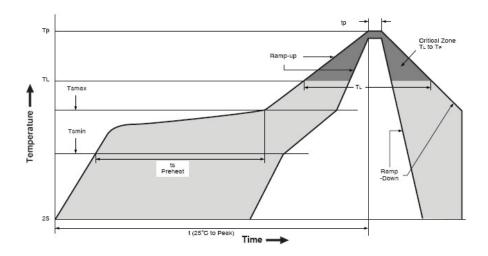








2. Recommend reflow profile:



Description	Parameter	Pb free
Average ramp rate	T _L to T _P	3 °C/sec max
Preheat		
Minimum temperature	T _{SMIN}	150 °C
Maximum temperature	T _{SMAX}	200 °C
Time(T _{SMIN} to T _{SMAX})	t _s	60 sec to 120 sec
Ramp-up rate	T _{SMAX} to T _L	1.25 °C/sec
Time maintained above liquidous temperature	t _L	60 sec to 150 sec
Liquidous temperature	TL	217 °C
Peak temperature	T _P	260 °C
Time within 5°C of actual peak temperature	t _P	20 sec to 40 sec
Ramp-down rate	T _P to T _{smax}	6 °C/sec max
Time 25 °C (t25 °C) to peak temperature	t	8 minutes max

3. note:

When washing the PCB, ensure that water does not make contact with the microphone port. Do not use blow-off procedures or ultrasonic cleaning.



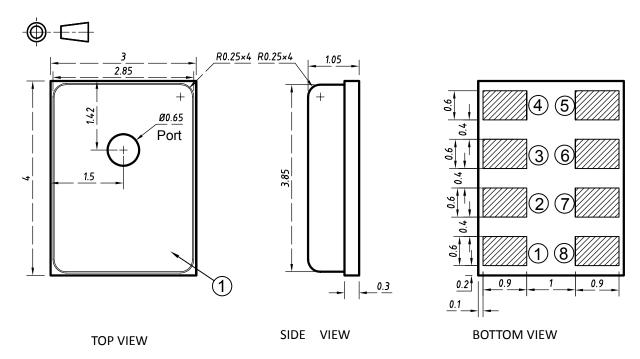








OUTLINE DIMENSIONS AND PIN DEFINITION:



1	GND	Ground	Connect to ground on the PCB.
	GIVD	Ground	Connect to ground on the FCB.
2	N/C	_	Do not connect
3	WS	Input	Serial Data-Word Select for I ² S Interface.
4	CHIPEN	Input	Microphone Enable. When set low (ground), the microphone is disabled and put in power-down mode. When set high (VDD), the microphone is enabled.
5	L/R	Input	Left/Right Channel Select. When set low, the microphone outputs its signal in the left channel of the I ² S frame; when set high, the microphone outputs its signal in the right channel.
6	SCK	Input	Serial Data Clock for I ² S Interface.
7	SD	Output	Serial Data Output for I ² S Interface. This pin tristates when not actively driving the appropriate output channel. The SD trace should have a 100 k Ω pull-down resistor to discharge the line during the time that all microphones on the bus have tristated their outputs.
8	VDD	Power	1.8 to 3.3 V. This pin should be decoupled to Pin 6 with a 0.1 μF capacitor.

Item	Dimension	Tolerance
Length (L)	4.0	±0.10
Width (W)	3.0	±0.10
Height (H)	1.05	±0.10
Acoustic Port (AP)	Ø0.65	±0.10

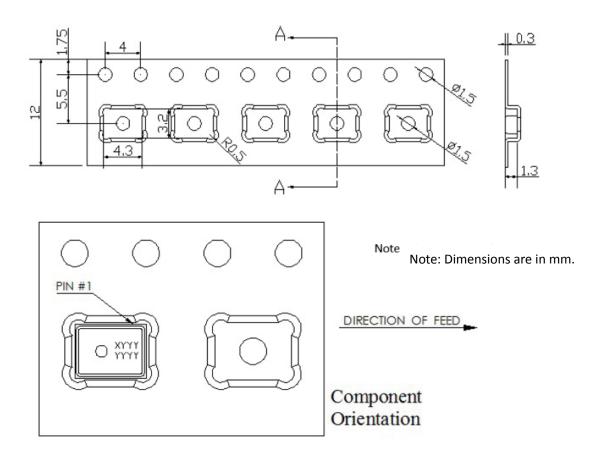
Dimensions are in millimeters

Tolerance is ±0.1mm unless otherwise specified.





PACKAGING & MARKING DETAIL:



Model Number	Reel Diameter	Quantity Per Reel	
MSM26S4030H0	13 inch	5000	



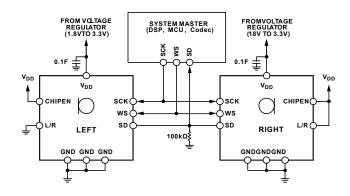


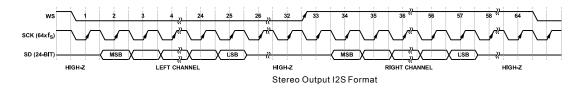


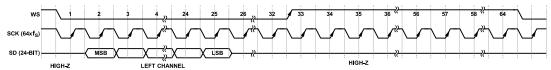




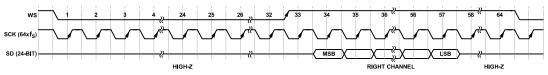
RECOMMENDED INTERFACE CIRCUIT:







Mono Output I2S Format Left Channel (L/R=0)



 $Mono\ Output\ I2SFormat\ Right\ Channel\ (L/R=1)$

I²S DATA INTERFACE

The serial data is in slave mode I²S format, which has 24-bit depth in a 32 bit word. In a stereo frame there are 64 SCK cycles, or 32 SCK cycles per data-word. When L/R=0, the output data in the left channel, while L/R=Vdd, data in the right channel. The output data pin (SD) is tristated after the LSB is output so that another microphone can drive the common data line.

Data Word Length

The output data-word length is 24 bits per channel. The Mic must always have 64 clock cycles for every stereo data-word (fSCK = $64 \times fWS$).

Data-Word Format

The default data format is I²S, MSB-first. In this format, the MSB of each word is delayed by one SCK cycle from the start of each half-frame.

MSM261S4030H0

I²S digital output MEMS microphone











REVISION HISTORY:

Revision	Subjects (major changes since last revision)	Date
1.0	Initial release	2015-1
1.1	Modified the outline dimension	2015-02-12

公司销售、技术支持联系方式

For English:

MEMSensing Microsystems Co. Ltd.

No. 99 Jinji Lake Avenue, Bldg. NW-09, Suite 501

Suzhou Industrial Park, China 215123

Phone: +86 512 62956055

Fax: +86 512 62956056

(http://www.memsensing.com)

中文用户:

苏州敏芯微电子技术有限公司

苏州工业园区金鸡湖大道 99 号, NW-09 楼, 501 室

中国 215123

电话: +86 512 62956055

传真: +86 512 62956056

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